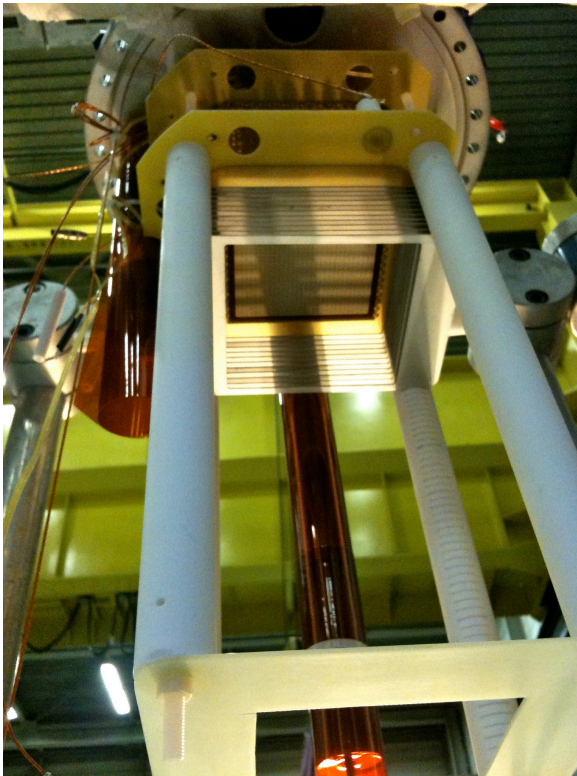


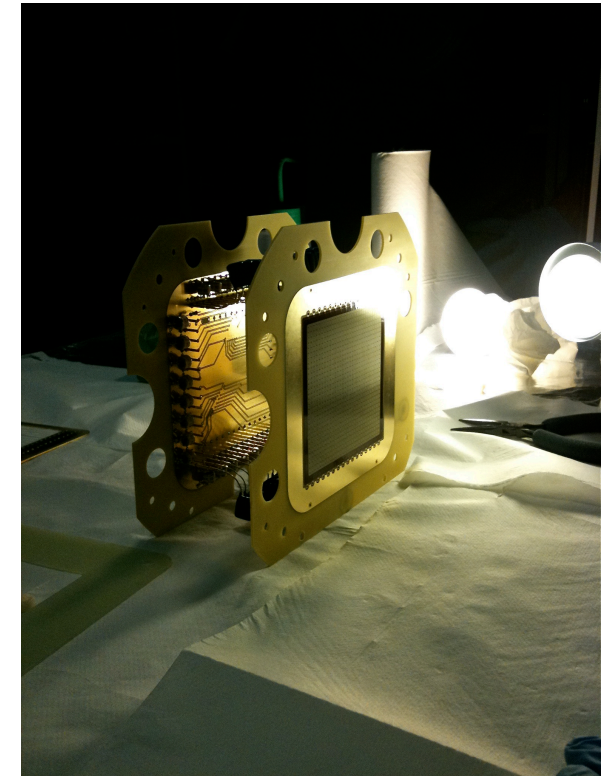
First tests of Micromegas in double phase liquid Argon

O. Besida, **A. Delbart**, E. Ferrer-Ribbas,
F.J. Iguaz, A. Longhin,
E. Mazzucato, G. Vasseur and M. Zito
*CEA/DSM-IRFU,
CE-Saclay, 91191 Gif-Yvette, France*

A. Badertscher, A. Curioni, L. Epprecht,
L. Knecht, D. Lussi, A. Marchionni, G. Natterer,
F. Resnati and A. Rubbia
*ETH Zurich, 101 Rämistrasse,
CH-8092 Zurich, Switzerland*



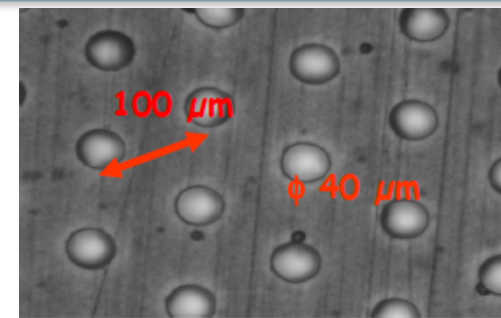
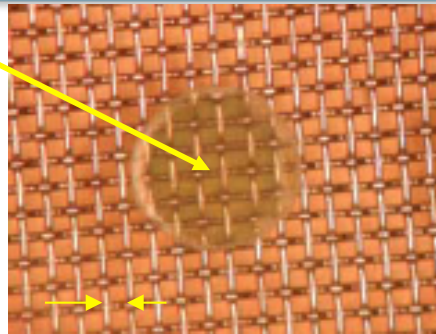
CEA DSM Irfu



- Introduction : scope of this study and gain measurements in high pressure Argon at room temperature
- First operation of a 100 μm bulk-micromegas in double phase Liquid Argon
 - TPC Setup
 - The bulk-micromegas design and operation
 - Preliminary results : gallery of cosmic tracks and estimate of the achieved gain
- Conclusion

Comparison of bulk & micro-bulk technologies

Top 500 μm pillar



63 μm pitch, 18 μm wires

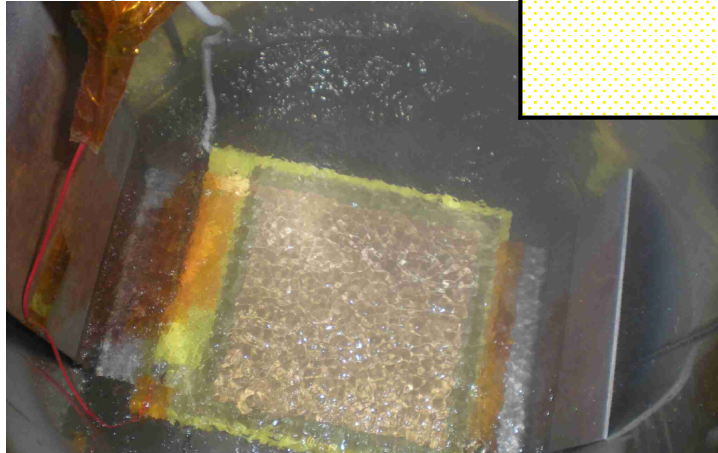
	bulk	micro-bulk
Standard amplification gap	128 μm	50 μm
Other possible amplification gaps	(64)-100-150-194 μm	(12.5)-25 μm
Standard Mesh pitch	63 μm	100 μm
Standard Mesh openings	45 μm	40 μm
Standard maximum size	40x40 cm^2	10x10 cm^2
R&D maximum size	500x1500 cm^2	30x30 cm^2
Best FWHM 5.9 keV resolution	8%	6%
Currently in use in experiments	T2K/TPC	Axion CAST experiment, nTOF
Current R&D programs	ILC/TPC, ILC/DHCAL, SLHC/Muon chambers upgrade, CLAS12 spectrometer, ...	NEXT, MIMAC, ...

- Large size
- Large scale production

- Low-budget material
- Excellent energy resolution
- < 50 μm amplification gap

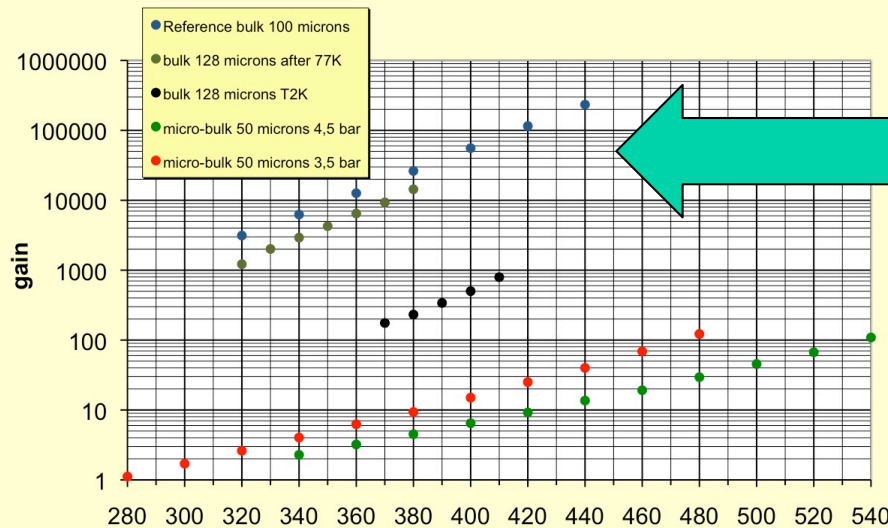
Robustness test of a bulk-micromegas @ 77K

Depth (mm)	T (°C)	Max Vmesh (V)	Max Eamp (kV/cm)
40	-47	670	52,3
25	-78	750	58,6
8	-119	850	66,4
0	-163	975	76,2
-10	-196	1300	101,6



Rough CTE @ 20°C

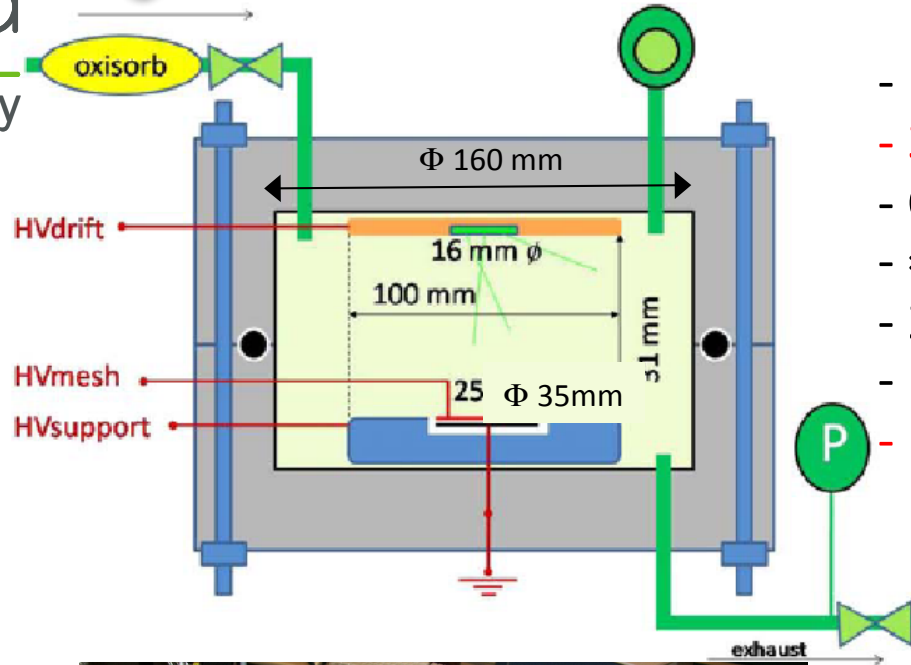
Material	CTE (ppm/°C)
FR4	14-16
copper	17-18
304L stainless steel	14-17
Pyralux PC1025	100-130



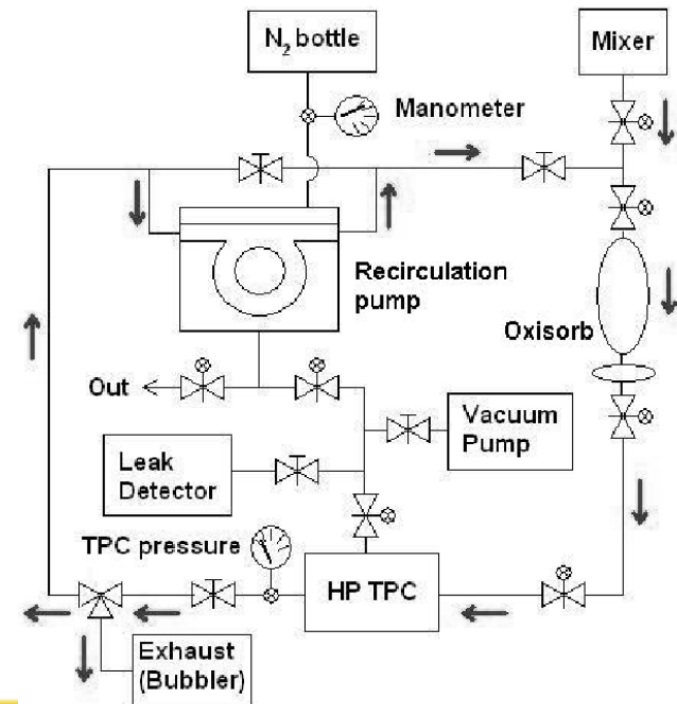
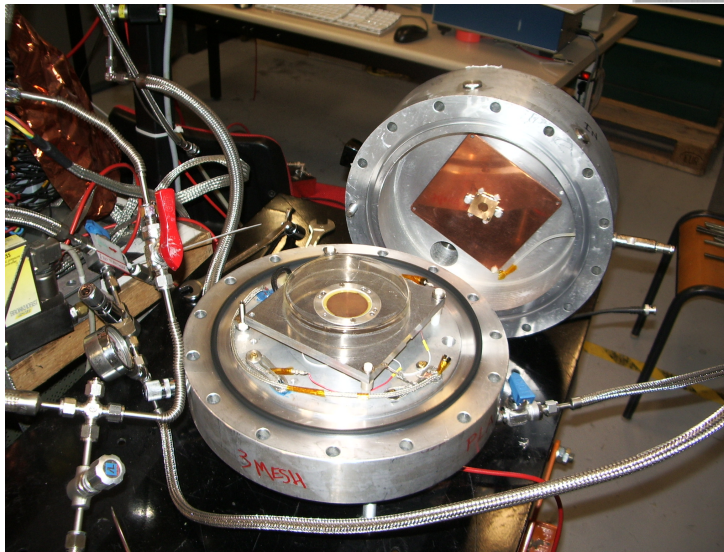
After drying of the detector @ 80°C for 1 night
Gain was measured in Ar+5% iC_4H_{10} at 1 bar

Bulk-micromegas seems to be robust enough to be operated at cryogenic temperatures

Ref: A. Delbart *et al.*, GLA2010, proceedings of 1st International Workshop towards the Giant Liquid Argon Charge Imaging Experiment



- Former Hellaz experiment chamber
- 35 mm diameter 25 & 50 μm micro-bulk
- Ortec 142C preamp
- $\approx 100 \text{ Bq } ^{241}\text{Am}$ alpha source
- 200 Hz counting rate
- $N_p = 2 \cdot 10^5 e^-$
- no particular purification (Ar-60)



Microbulk Gain in Argon @ room temperature

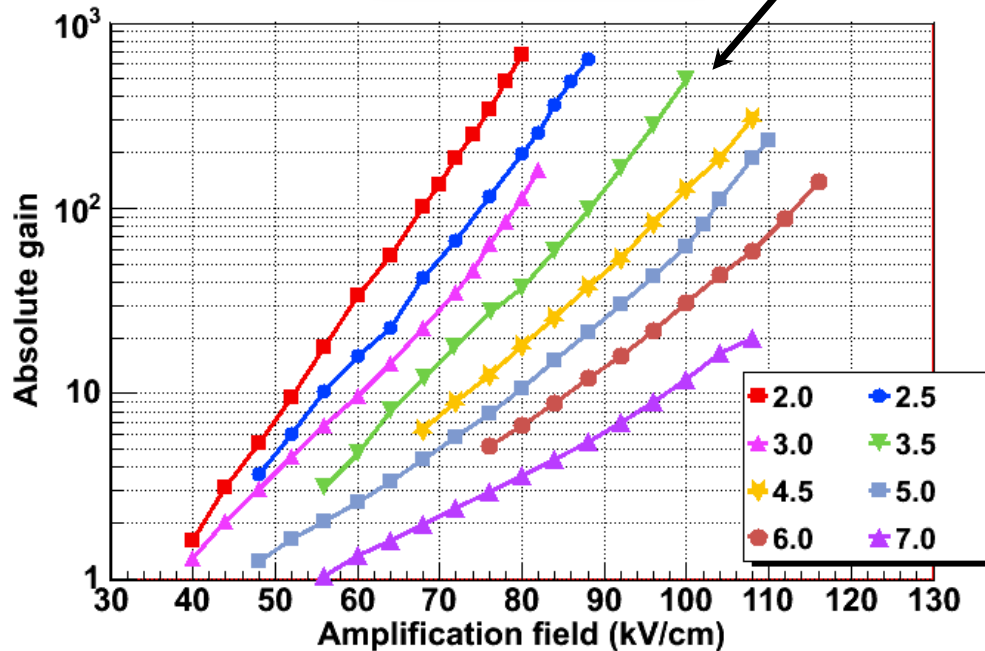


saclay

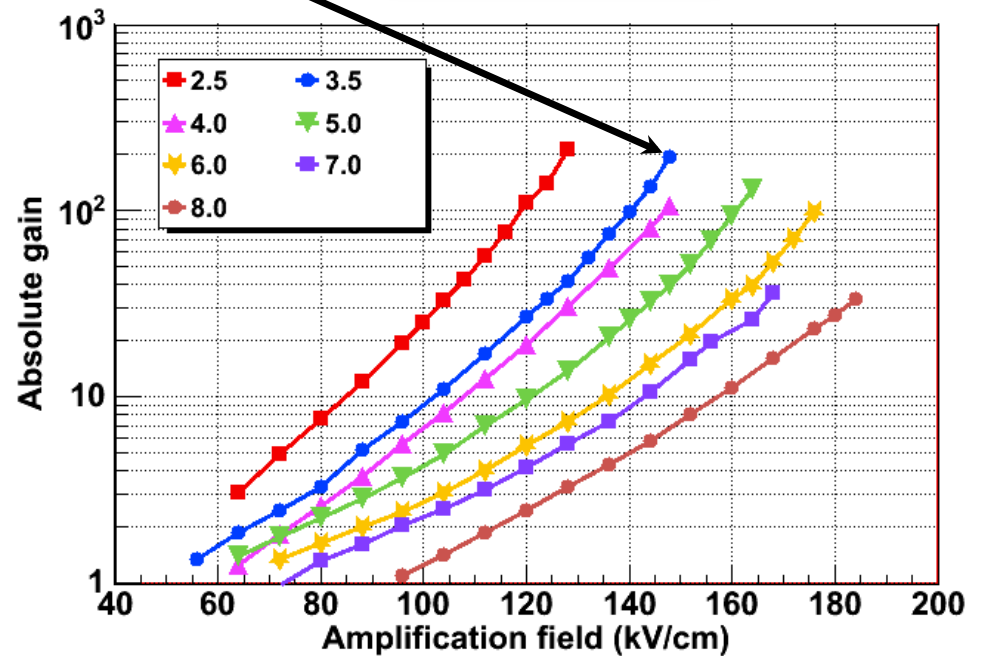


@ 3,5 bars at room temperature

50 μm microbulk

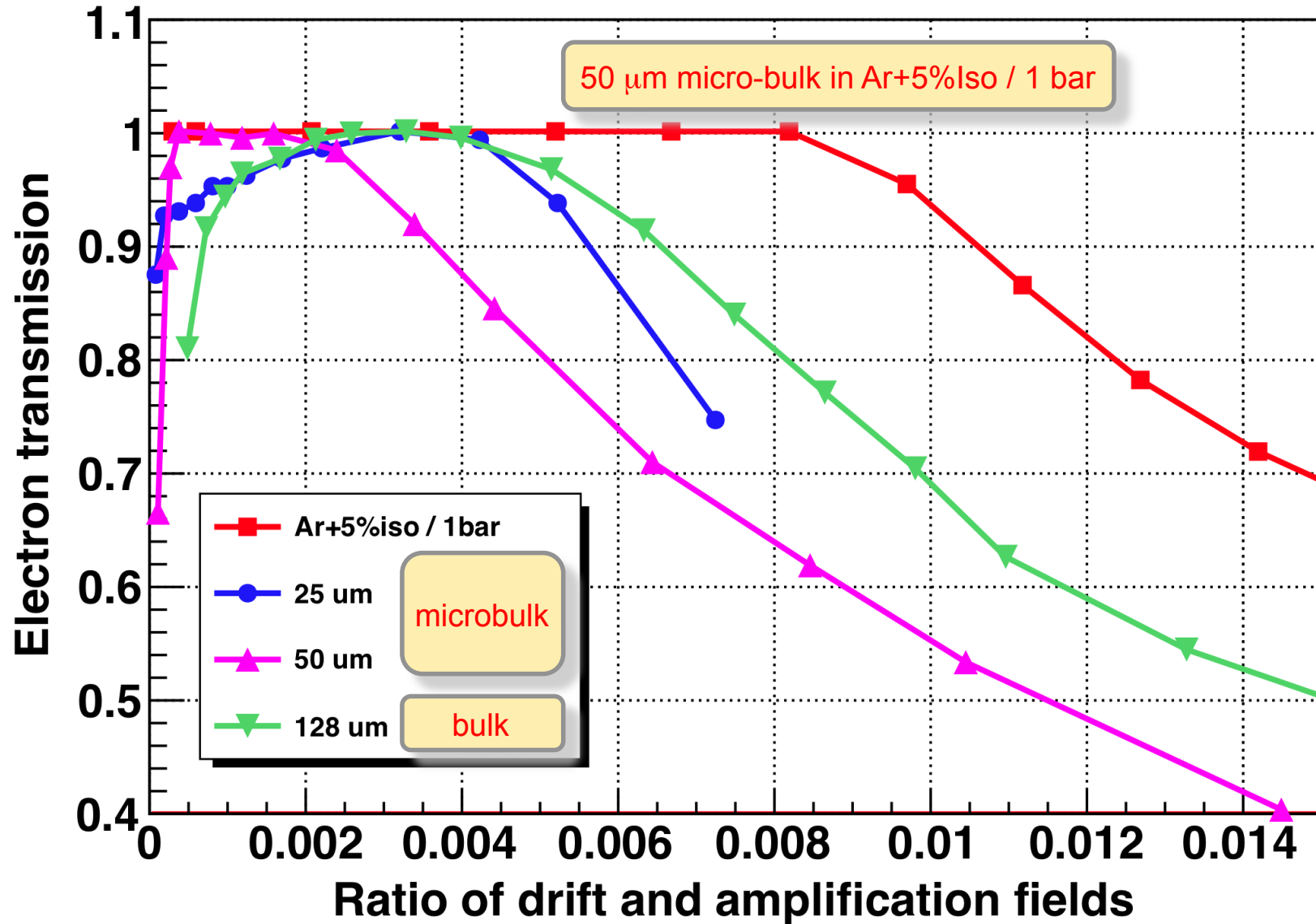


25 μm microbulk



Ref: F. J. Iguaz, New results of micromegas (microbulk) detectors, Freiburg RD51 collab. Meeting, may 25th 2010

High gain achieved but how does this compare to double phase very pure argon conditions ?

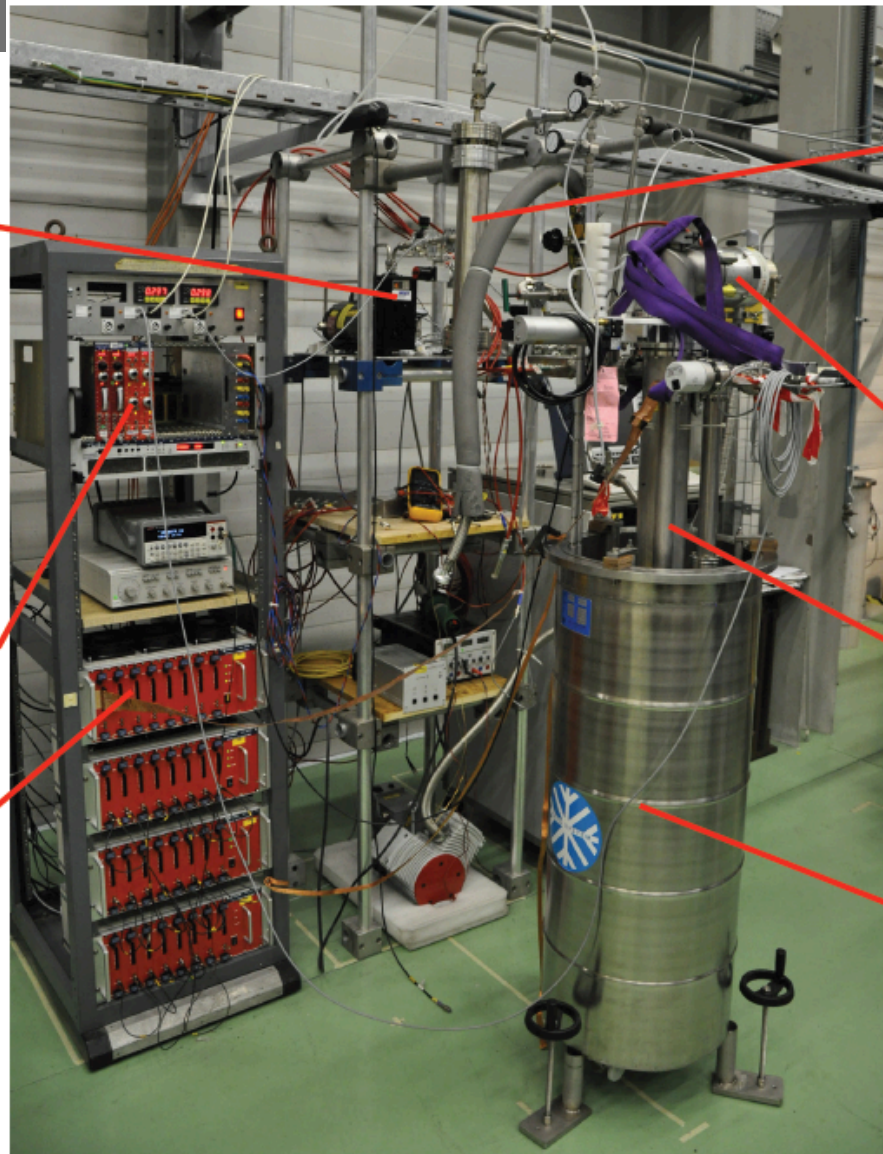


Ref: D. Lussi's talk

argon
purification
system

power supplies

charge
DAQ
system



input LAr
purification
cartridge

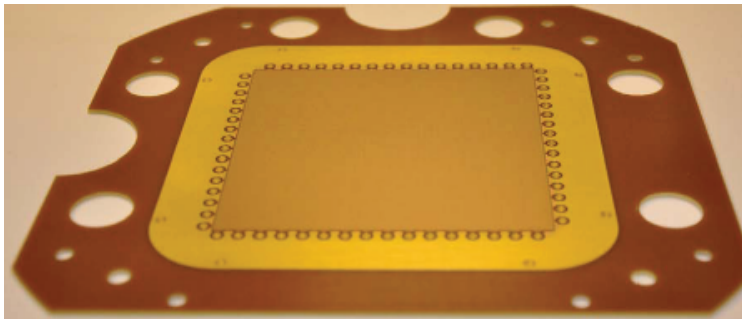
turbo pump

detector
vessel

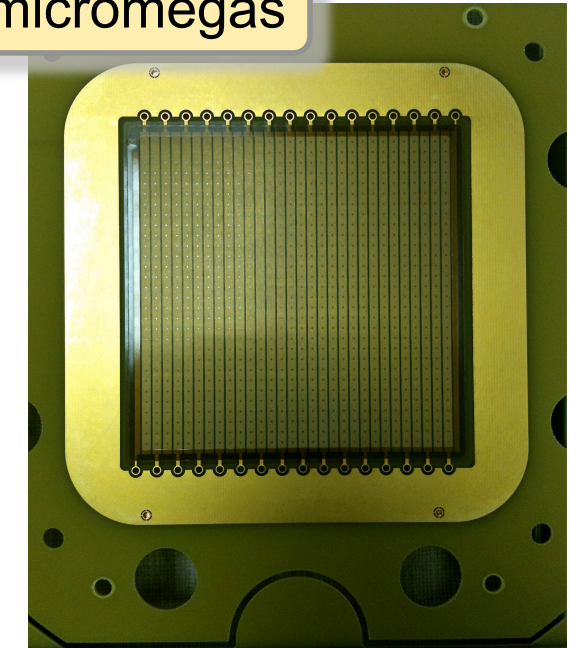
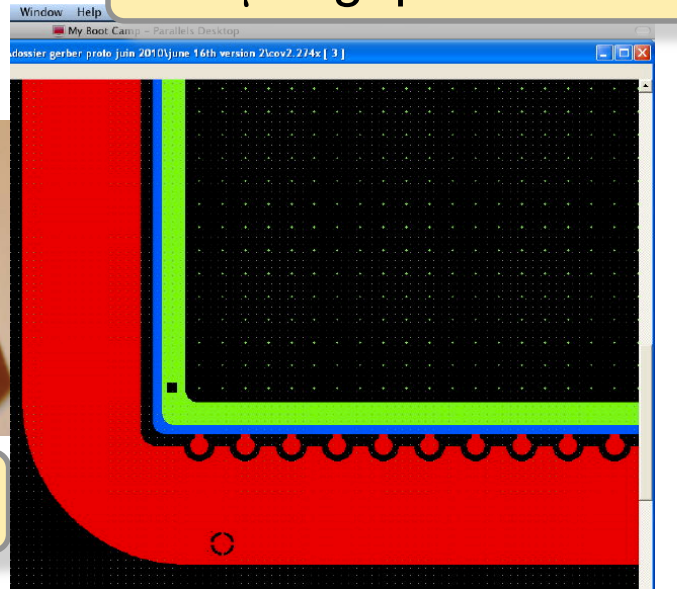
cryostat
(LAR bath)

100 μm gap 1D bulk-micromegas

Ref: D. Lussi's talk



The double LEM 2D readout anode PCB

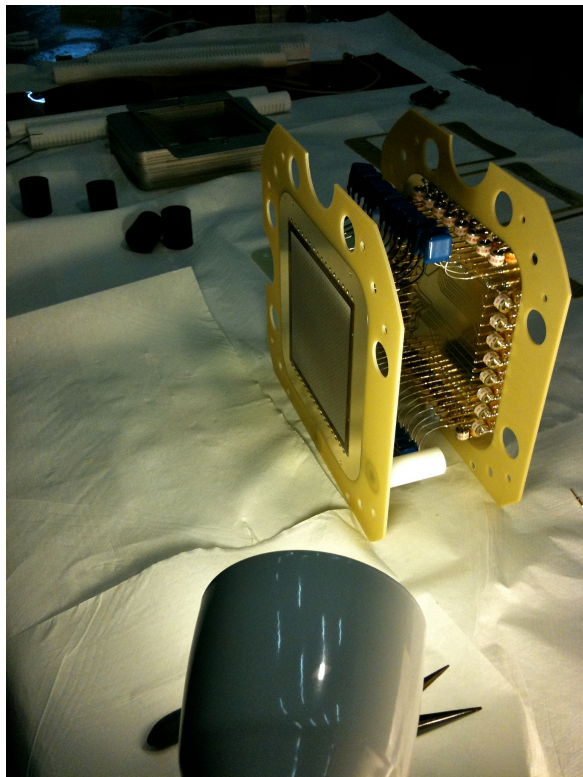


Goal : Operation & Gain measurements with a bulk-micromegas

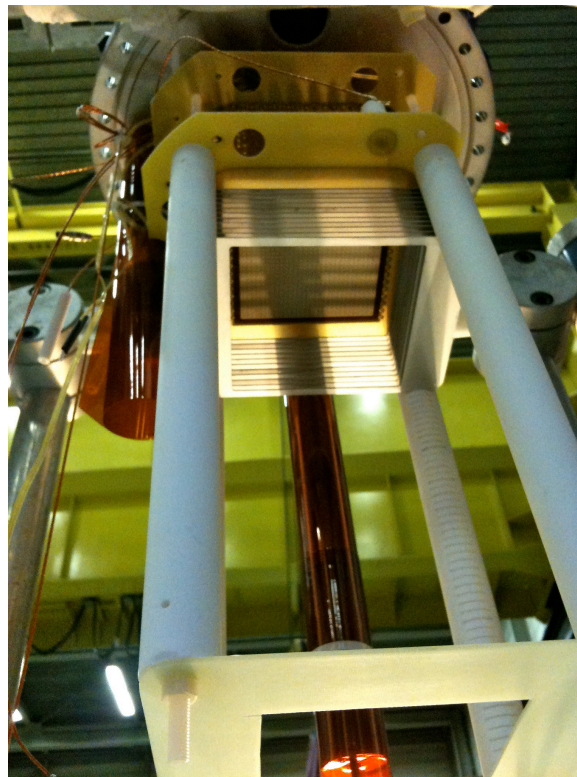
In place of the double LEM 2D readout. Installation & tests during august 2010.

- Mechanical & electrical interfaces of the double LEM anode PCB are kept unchanged for direct integration in the 31 ETHZ Lar TPC
- Only 1D readout with 32 strips, 3.1 mm pitch (the 2D « GEM-COMPASS-like » readout is not suitable for charge collection in micromegas)
- a 5 mm border surrounding the active area is used for woven-micromesh termination
- 2 bulk-micromegas were done : 128 μm gap & 100 μm gap
- The modified PCB & the bulk-micromegas were manufactured by CERN/EN-ICE-DEM

The bulk-micromegas
Is first assembled
With the signal PCB



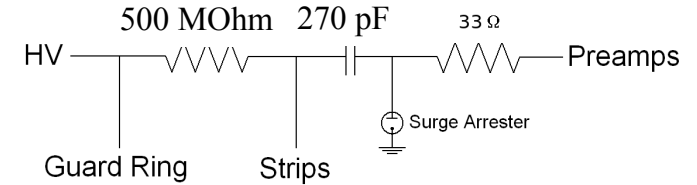
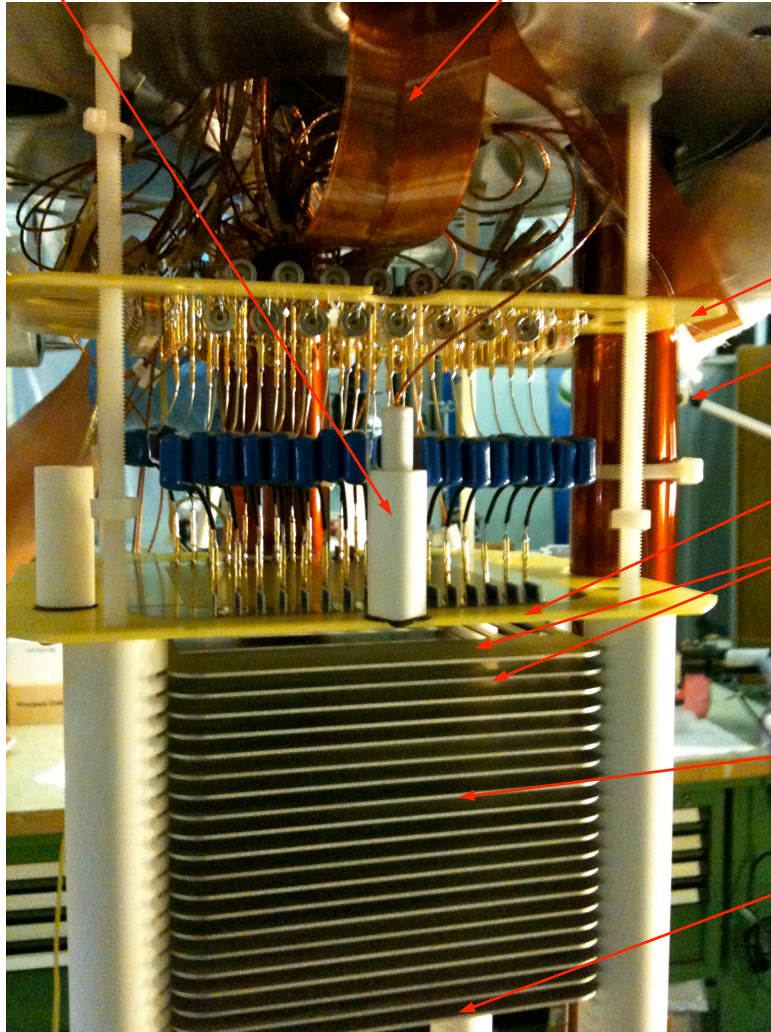
Assembly of the TPC
field cage, cathode
& micromegas PCB



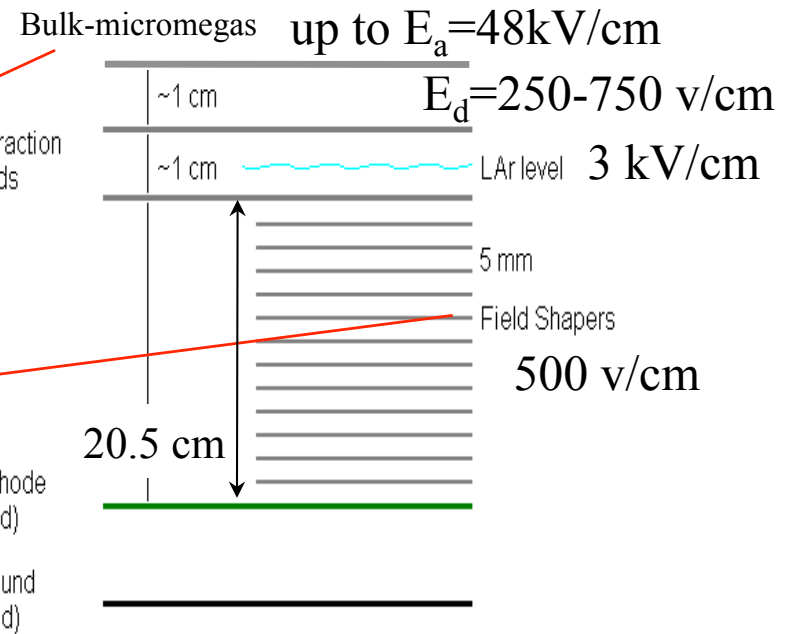
Integration
Of the TPC
In the Cryostat



Bulk-micromegas Strip readout mesh HV



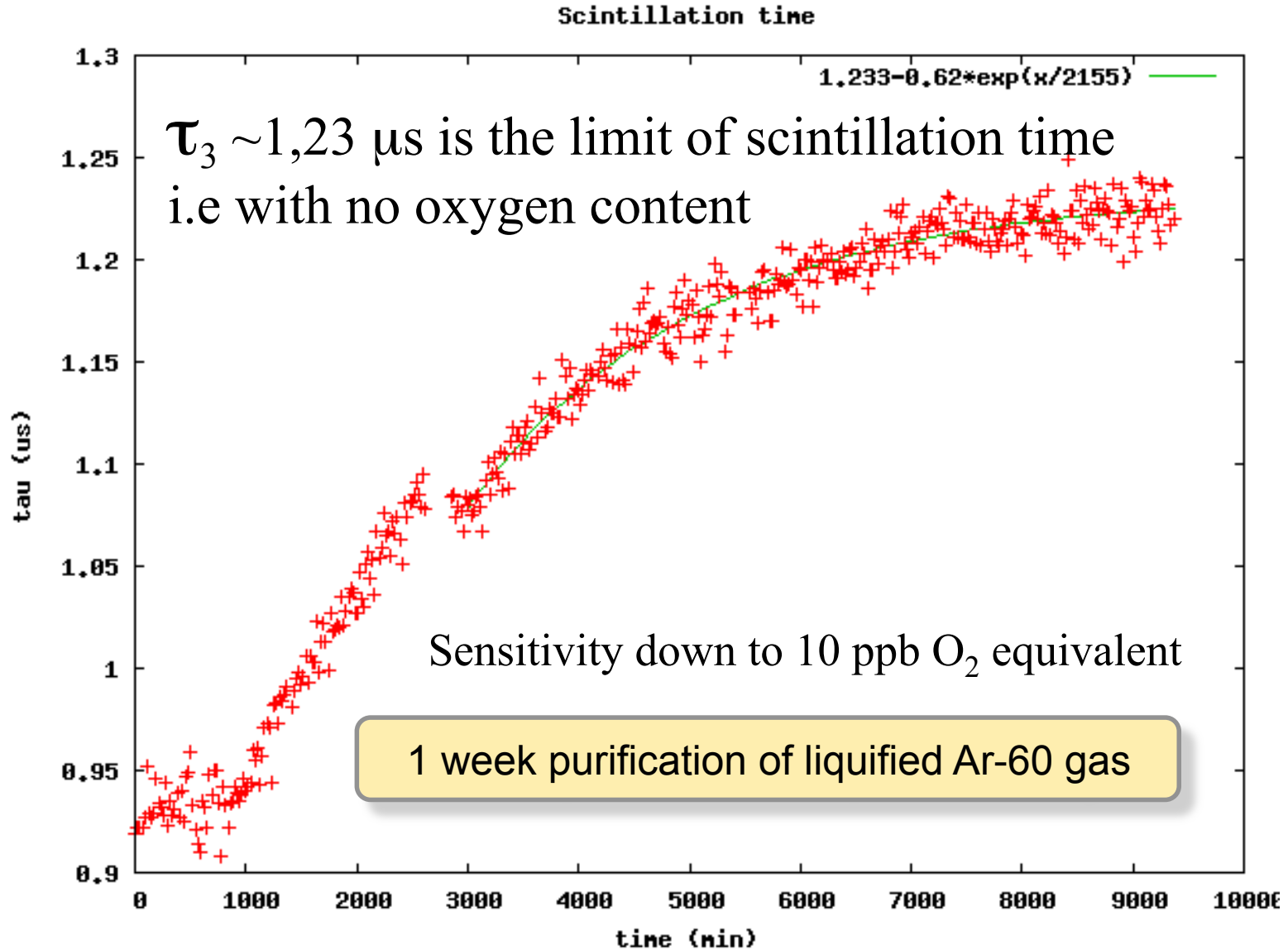
Signal plane 30 kV feedthrough



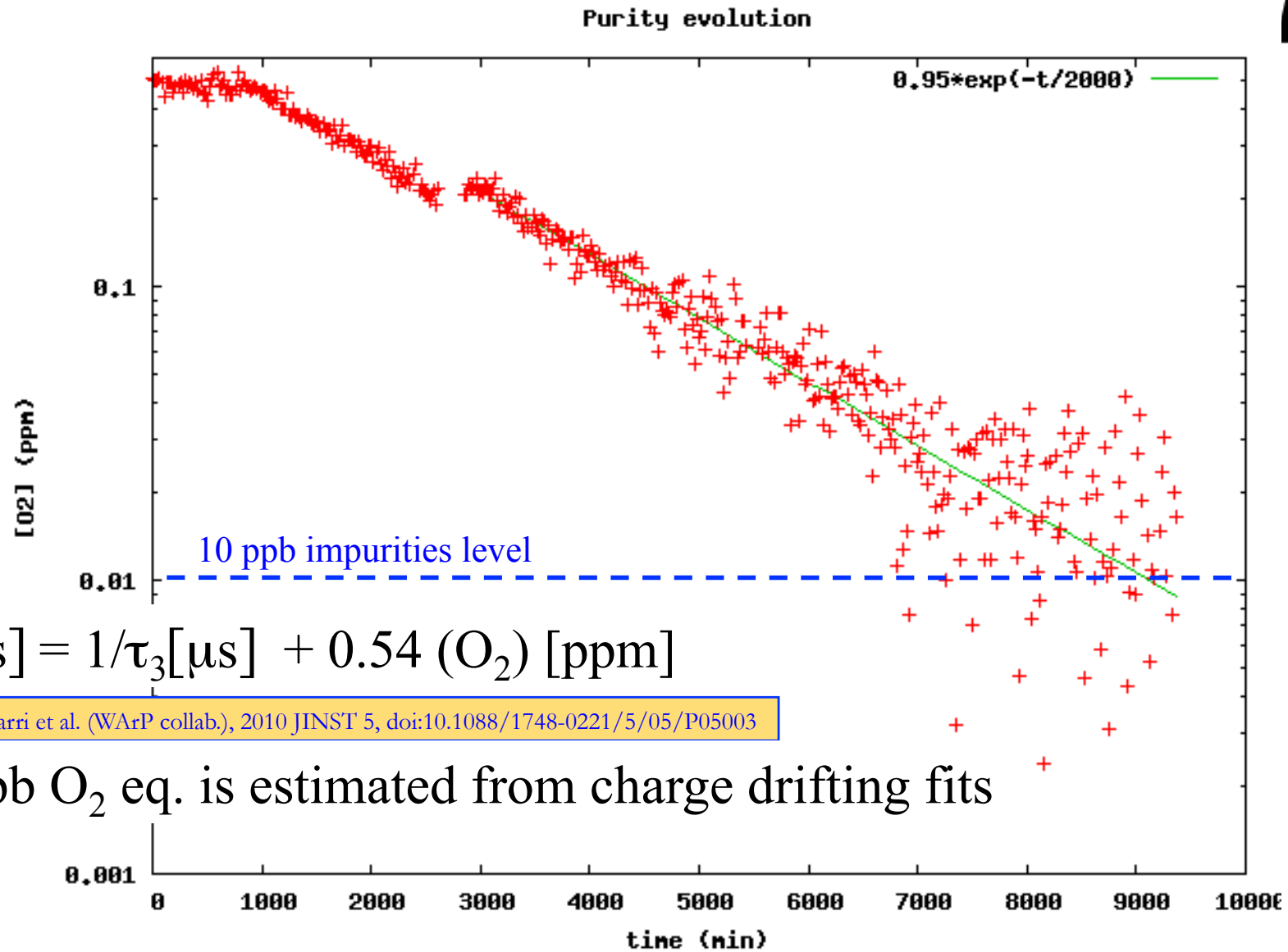
PMT

TPB coated

Argon purity is monitored from the slow component scintillation time



Oxygen eq. content evolution (scintillation)



$$1/\tau[\mu\text{s}] = 1/\tau_3[\mu\text{s}] + 0.54 (\text{O}_2) [\text{ppm}]$$

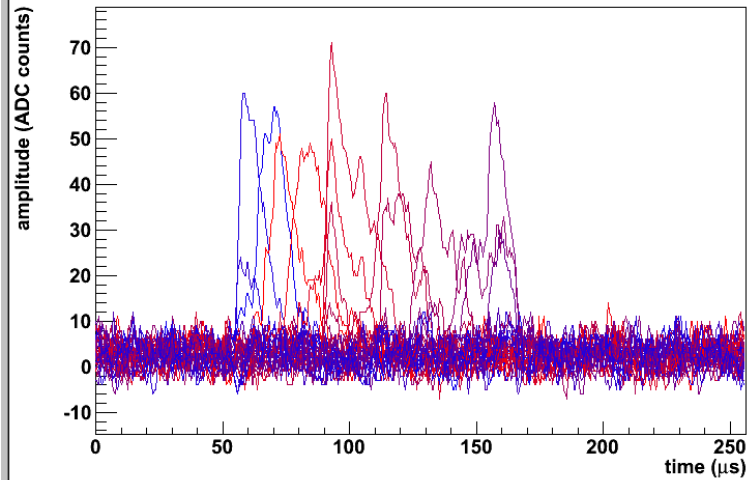
Ref: R. Acciarri et al. (WArP collab.), 2010 JINST 5, doi:10.1088/1748-0221/5/05/P05003

~2 ppb O₂ eq. is estimated from charge drifting fits

Typical track at low gain (close to 1)



xView signals (event 31)



In LAr a MIP muon releases 2.1 MeV/cm @ 0.5 kV/cm → ~10 fC/strip (Gain 1)

$$E_{\text{Amp}} = 42\text{kV/cm} \quad \sim 10 \text{ fC/strip} \quad \text{Gain} \sim 1$$

Stable, no spark

Noise reduction

- No noise reduction
- Minimum subtraction
- Average subtraction
- Improved average subtraction
- test noise reduction

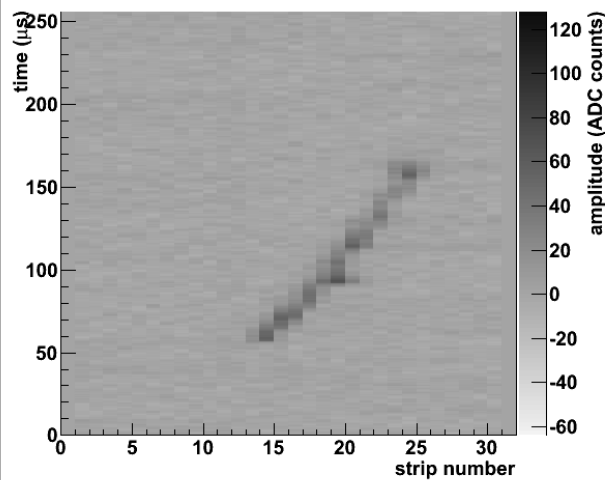
Drawing options

- show fits of anode signals
- Show 3D reconstruction
- Show clustering
- Show light analysis
- Subtract offset

Cut selection

- Muon tracks (used for dQ/dx)
- Contained events
- Crossing muon events

xView event display (event 31)

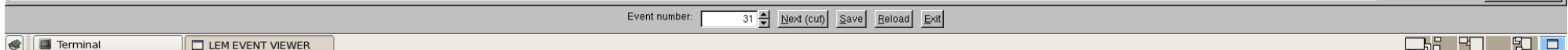
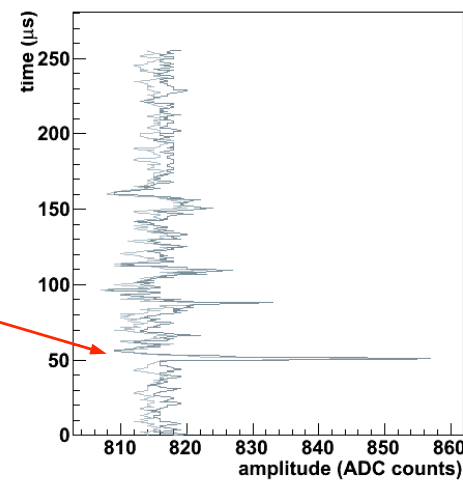


20,5 cm

Scintillation light due to muon crossing LAr

1 cm

PMT signal (event 31)



Typical track at middle gain (close to 3)

The screenshot shows the LEM EVENT VIEWER interface with the following components:

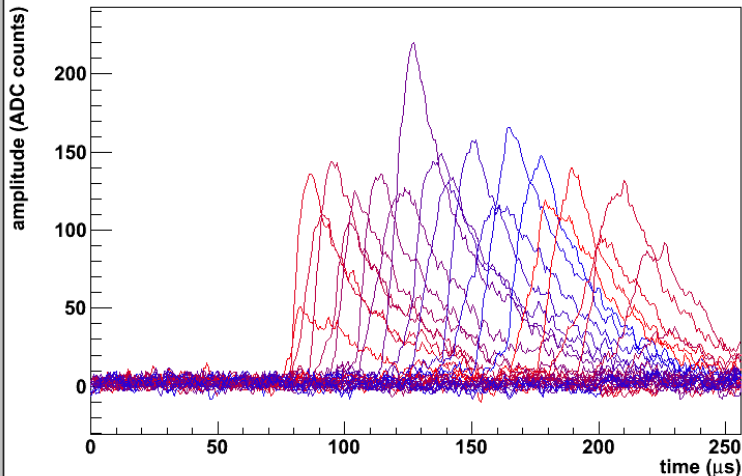
- Top Panel:** "xView signals (event 19)" showing a plot of amplitude (ADC counts) vs. time (μs). The plot displays multiple overlapping signal traces in red and blue, showing a clear peak structure between 50 and 150 μs.
- Summary Box:** A yellow box containing the text: $E_{Amp} = 46 \text{ kV/cm} \quad \sim 25 \text{ fC/strip} \quad \text{Gain} \sim 3$
- Configuration Panel:** On the right side, there are settings for "Noise reduction" (with "test noise reduction" selected), "Drawing options" (all unchecked), and "Cut selection" (with "Muon tracks (used for dQ/dx)" selected).
- Bottom Left Panel:** "xView event display (event 19)" showing a 2D heatmap of amplitude (ADC counts) vs. strip number vs. time (μs). The x-axis ranges from 0 to 30 strip numbers, and the y-axis ranges from 0 to 250 μs. A diagonal band of activity is visible.
- Bottom Right Panel:** "PMT signal (event 19)" showing a zoomed-in plot of time (μs) vs. amplitude (ADC counts). The x-axis ranges from 805 to 840 ADC counts, and the y-axis ranges from 0 to 250 μs. The plot shows a dense cluster of signal points.
- Bottom Bar:** Includes a terminal window, the application name "LEM EVENT VIEWER", and event controls: "Event number: 19", "Next (cut)", "Save", "Reload", and "Exit".

Stable, no spark best achieved operation conditions

Typical track at higher gain (close to 4)

xView signals (event 88)

LEM EVENT VIEWER



$E_{\text{Amp}} = 47 \text{ kV/cm} \quad \sim 40 \text{ fC/strip} \quad \text{Gain} \sim 4$

Limit before unstable operation (some sparks)

Noise reduction

- No noise reduction
- Minimum subtraction
- Average subtraction
- Improved average subtraction
- test noise reduction

Drawing options

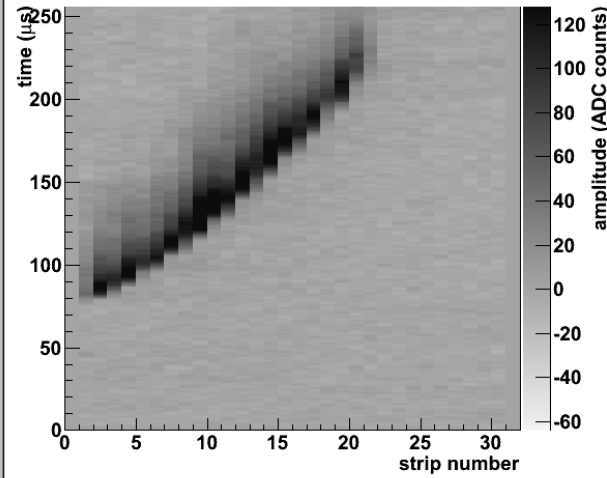
- show fits of anode signals
- Show 3D reconstruction
- Show clustering
- Show light analysis
- Subtract offset

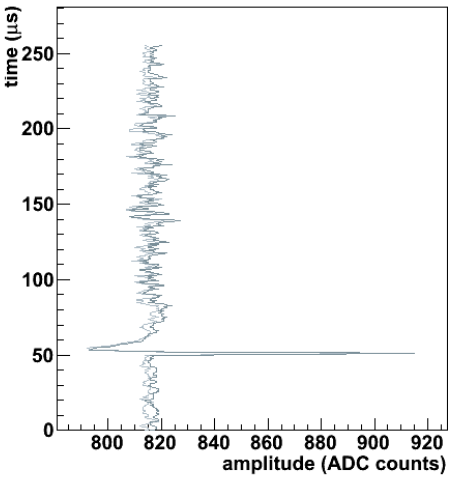
Cut selection

- Muon tracks (used for dQ/dx)
- Contained events
- Crossing muon events

xView event display (event 88)

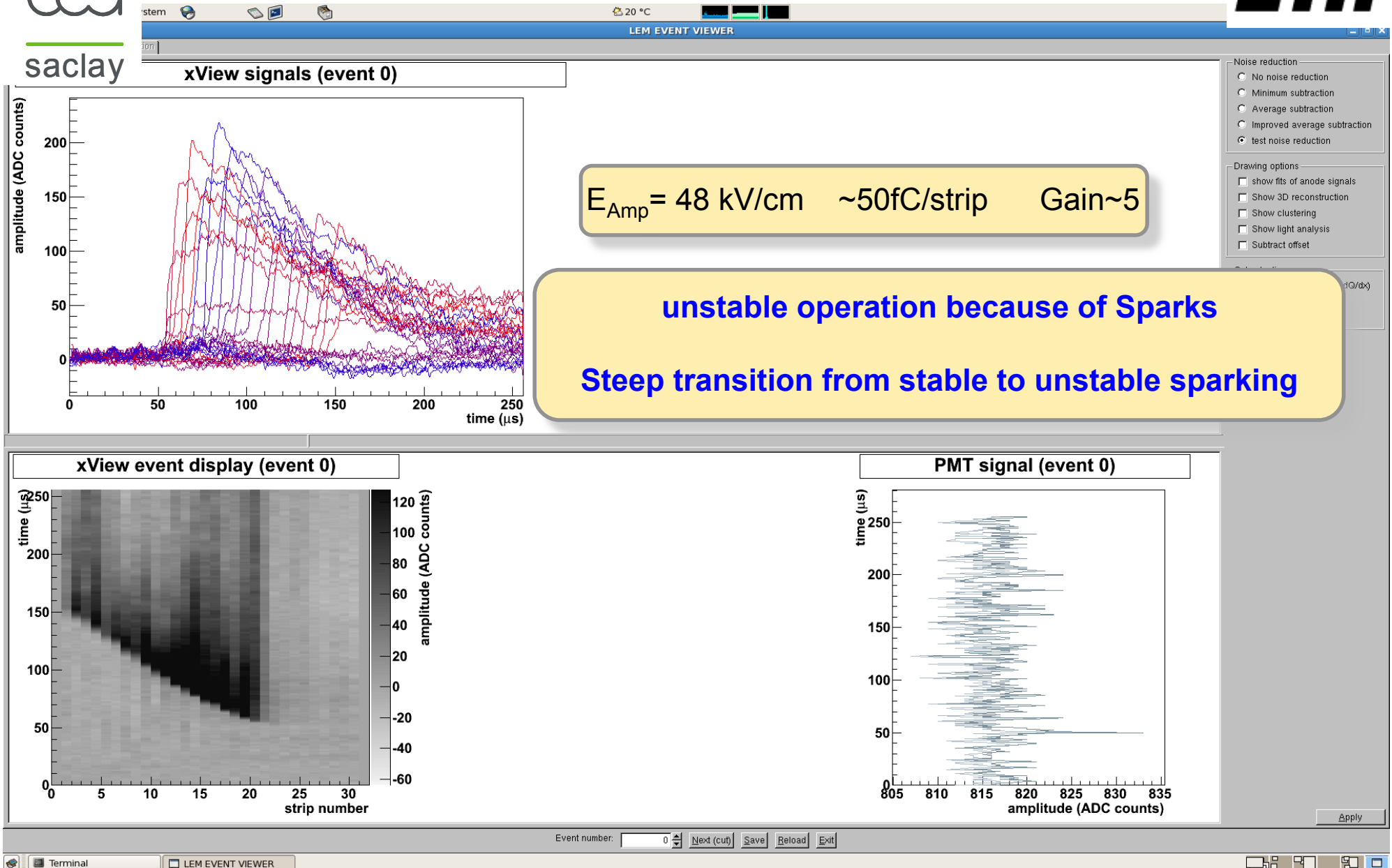
PMT signal (event 88)





Event number:
Next (cut)
Save
Reload
Exit

Typical track in unstable (close to 5)

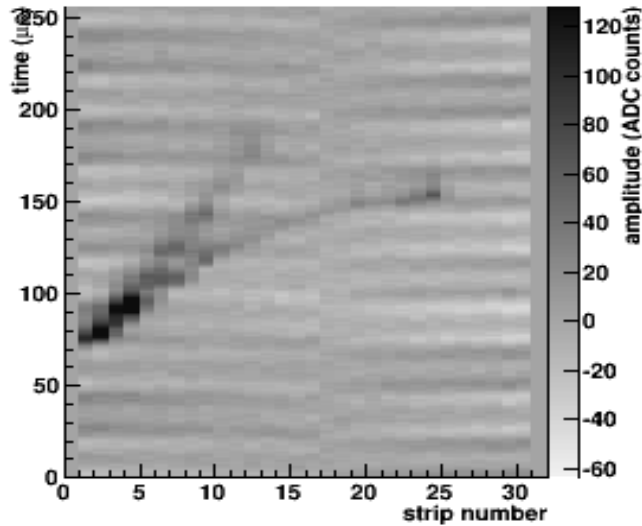


$E_{\text{Amp}} = 48 \text{ kV/cm} \quad \sim 50 \text{ fC/strip} \quad \text{Gain} \sim 5$

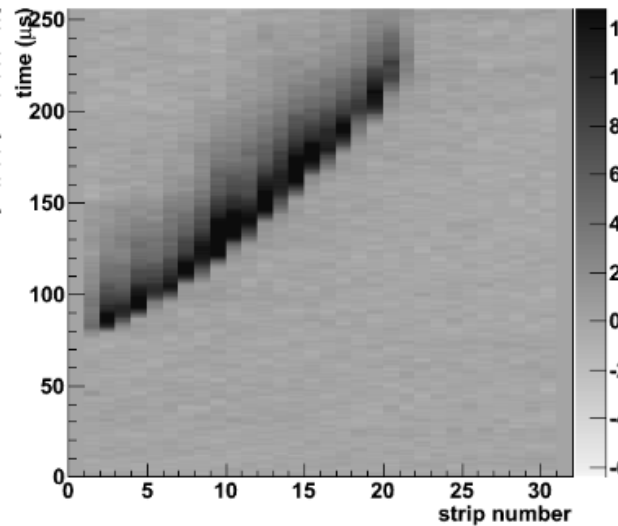
unstable operation because of Sparks

Steep transition from stable to unstable sparking

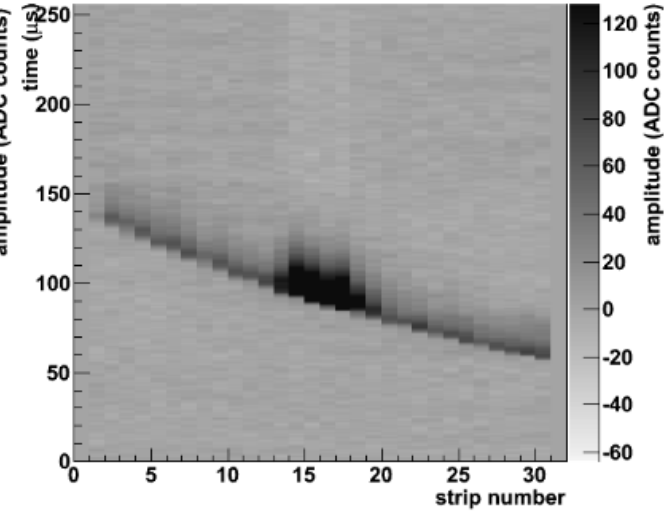
xView event display (event 523)



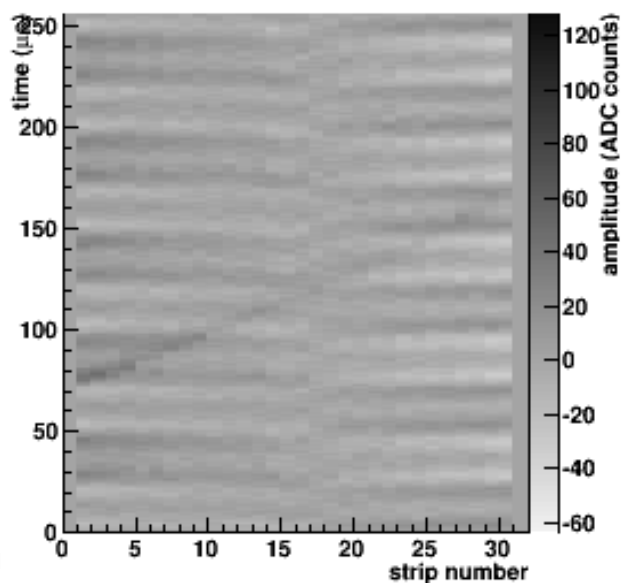
xView event display (event 88)



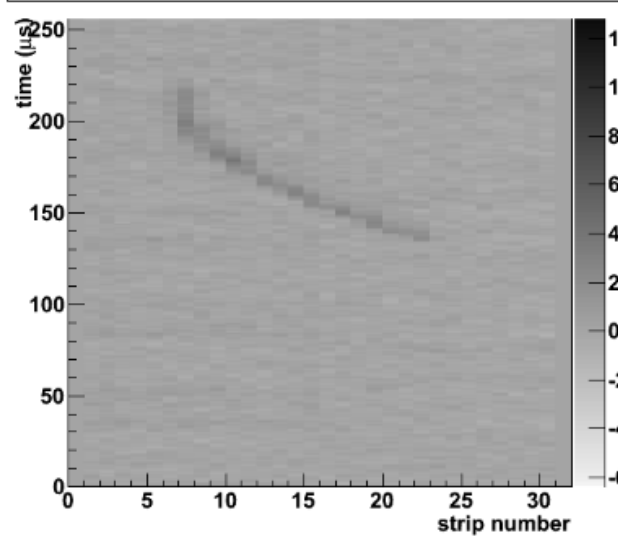
xView event display (event 26)



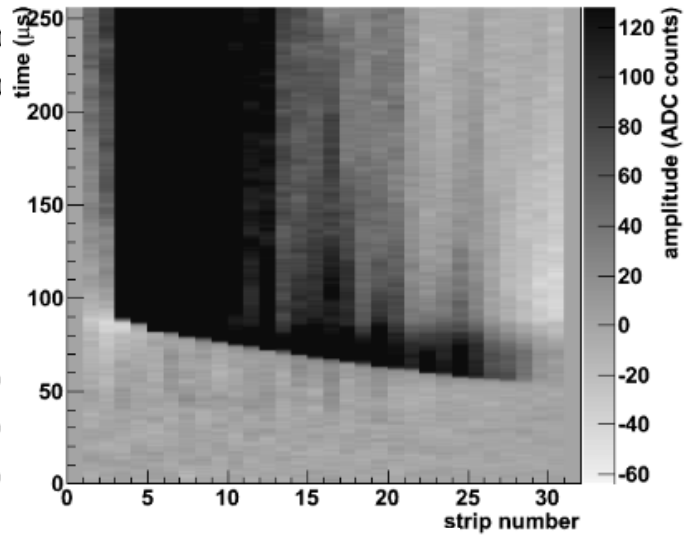
xView event display (event 449)



xView event display (event 39)

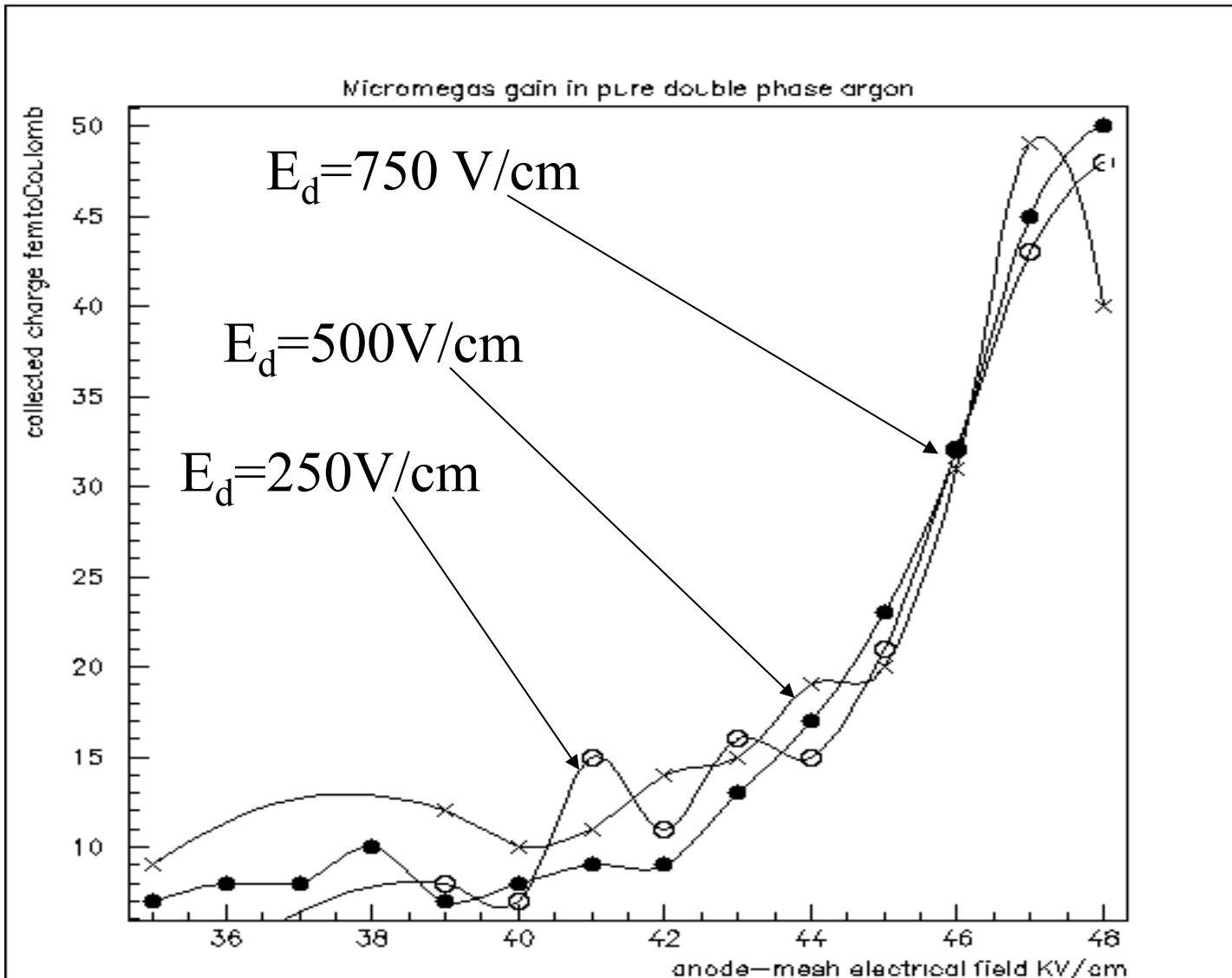


xView event display (event 32)



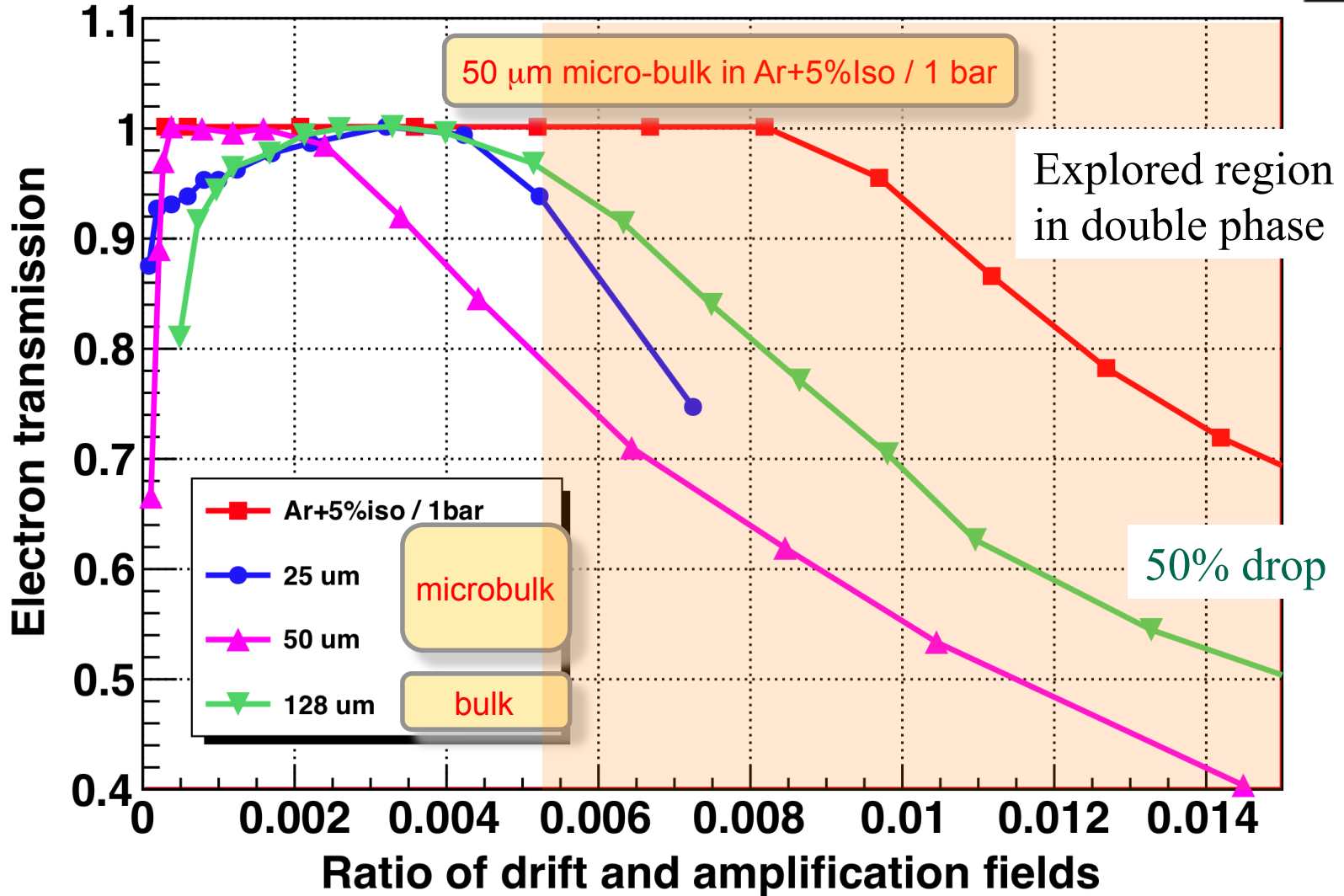
C

Collected charge Vs E_{drift}/E_{amp}



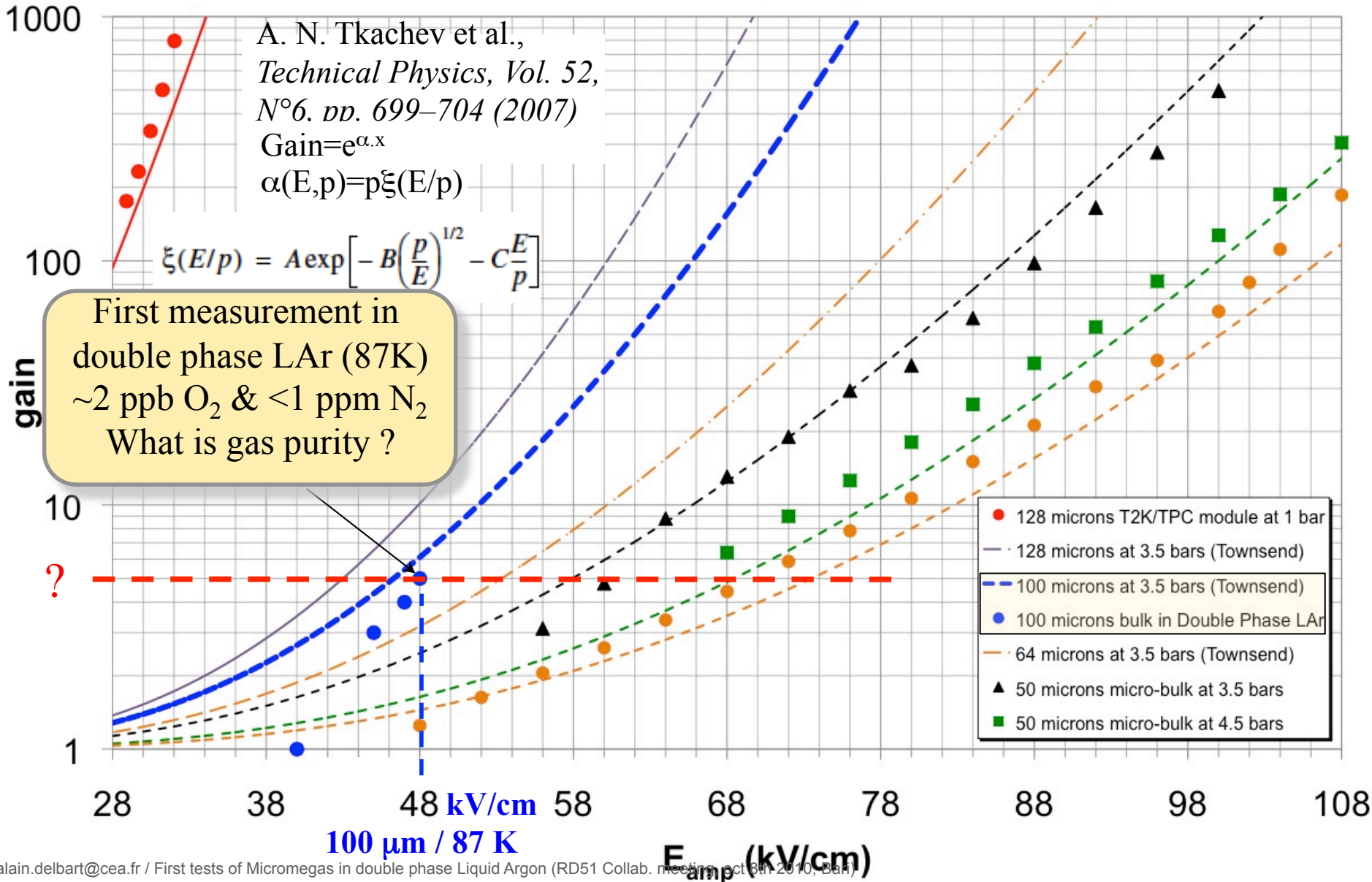
The collected charge does not seem to depend on the electric field ratio E_d/E_a

Electron transmission in 300K Argon at 3,5 bars (same gas density as 87K at 1 bar)

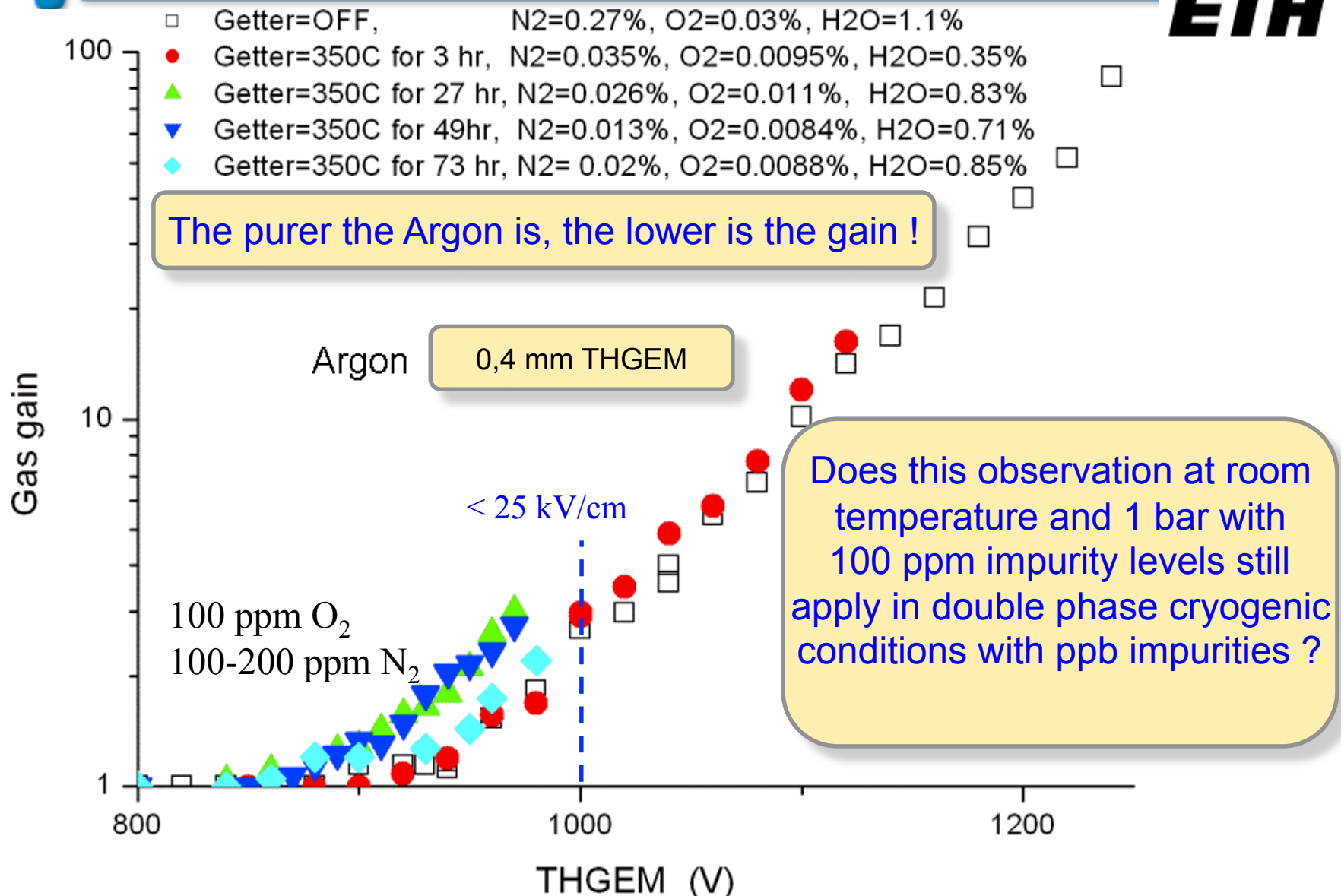


Why is this 50% loss of electrons not seen in cryogenic conditions (87K, 1 bar) ?

For Argon: $A = 43 \text{ (cm Torr)}^{-1}$, $B = 27.5 \text{ [V/(cm Torr)]}^{1/2}$, $C = 2.5 \cdot 10^{-4} \text{ (cm Torr)/V}$



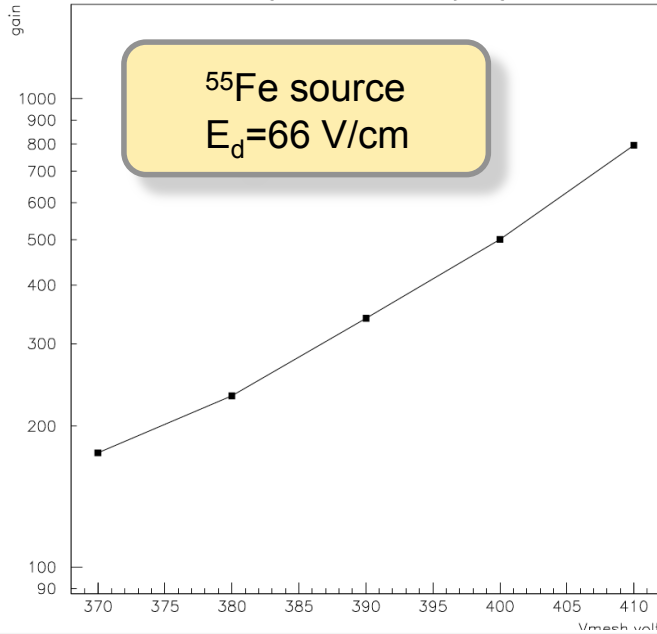
Gain limits in pure Argon : a possible explanation ?



Ref: J. Miyamoto, A. Breskin and V. Peskov, JINST 2010, doi:10.1088/1748-0221/5/05/P05008

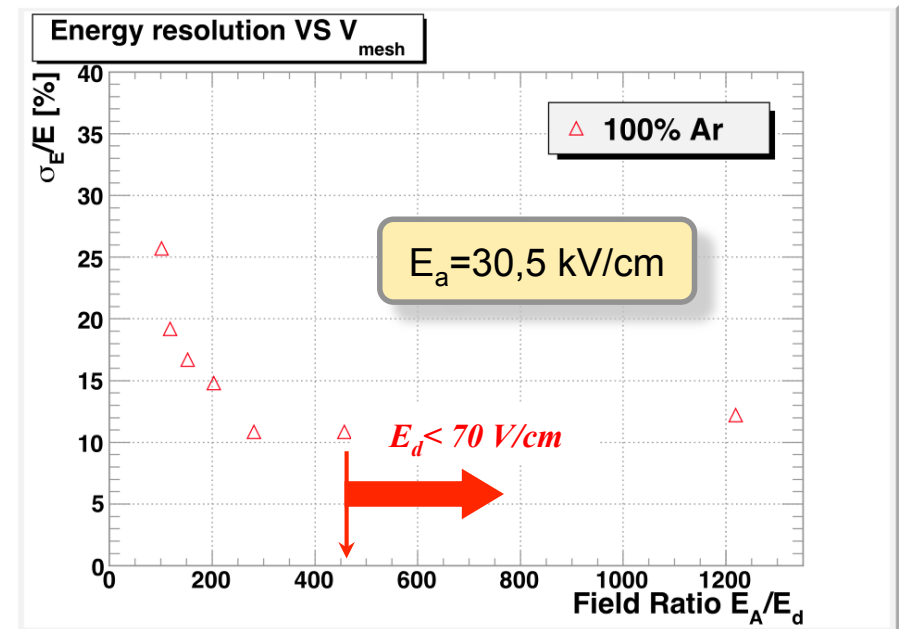
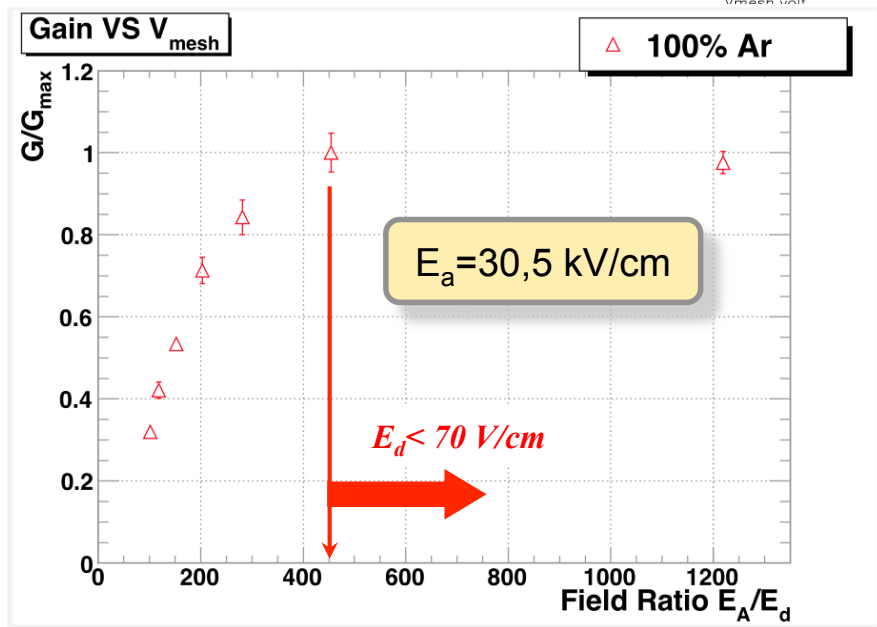
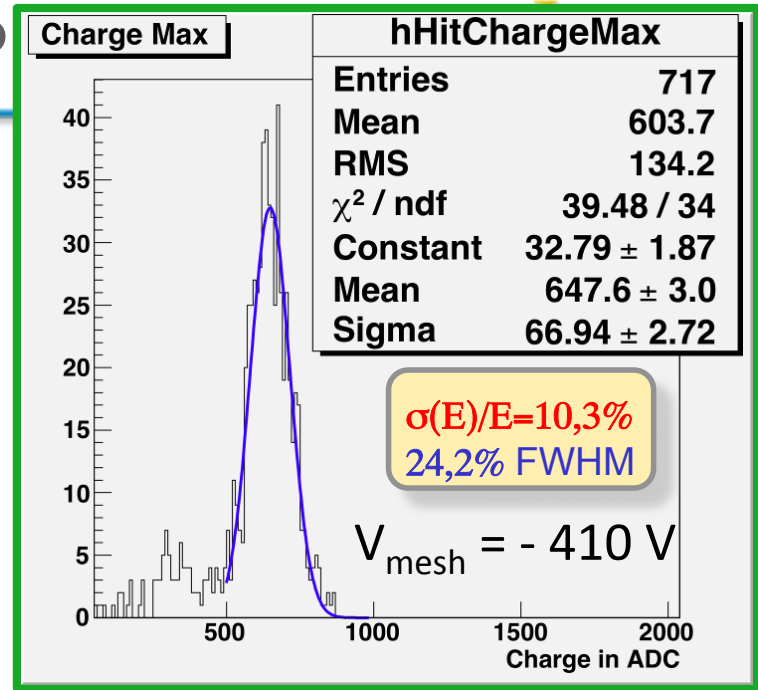
- A 100 μm gap bulk-micromegas was successfully operated in the 3l double phase Liquid Argon ETH-TPC
 - Stable operation in cryogenic environment at ~ 5 gain
 - ~ 2 ppb O_2 Liquid Argon purity achieved
 - First cosmic tracks observed
 - Maximum gain achieved of the order of ~ 5
 - A simple fit of the gain with a townsend law is consistent with the measured gain
- The maximum gain is low and may be due to the very high purity of Argon (which is demanded for charge drift in liquid)
- Such a low gain could be suitable for neutrino applications but higher gains (>100) are needed for dark matter search
- **But these are the first tests and further improvements and studies are planned (thinner bulk gaps, micro-bulk, ...)**

irfu T2K/TPC module in Ar @ STP



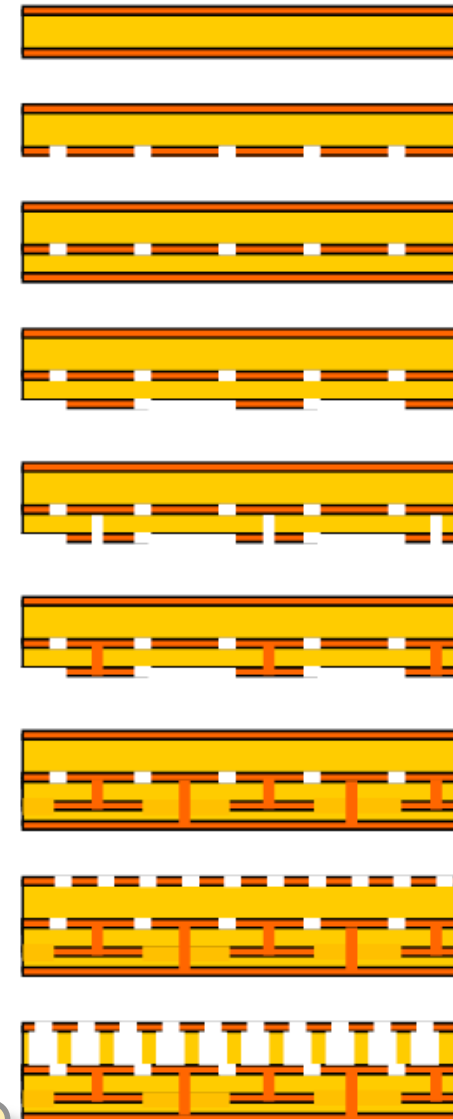
> 420 V

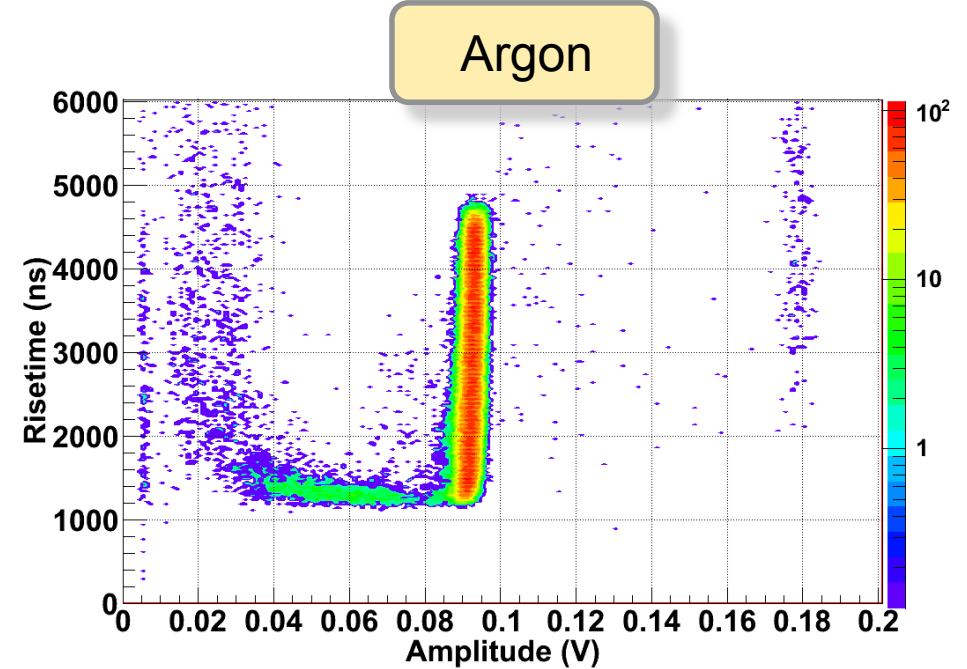
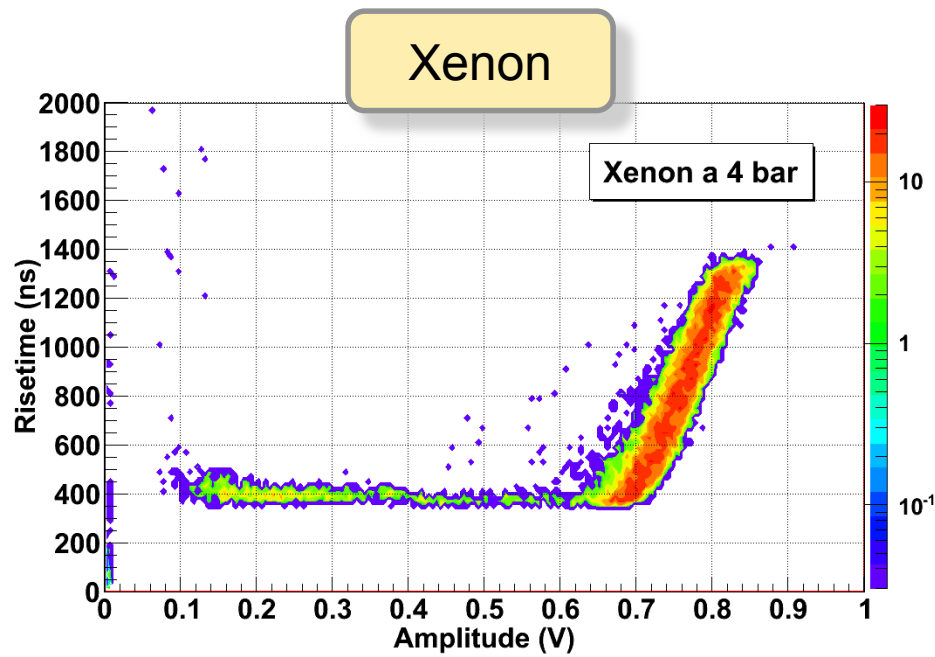
*High sparking rate region
(almost continuously)*



Building a Microbulk

- Kapton foil (50 μm), both side Cu-coated (5 μm)
- Construction of readout strips/pads (photolithography)
- Attachment of a single-side Cu-coated kapton foil (25/5 μm)
- Construction of readout lines
- Etching of kapton
- Vias construction
- 2nd Layer of Cu-coated kapton
- Photochemical production of mesh holes
- Kapton etching
- Cleaning



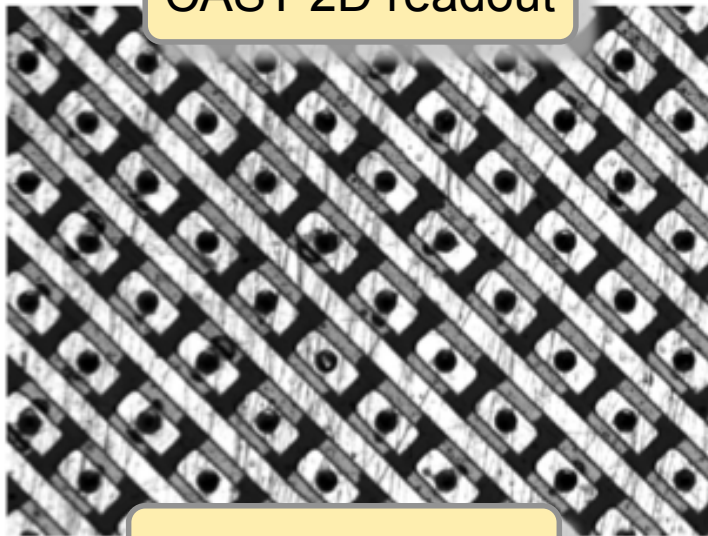


T. Dafni et al. NIM A 608 259-266, 2009

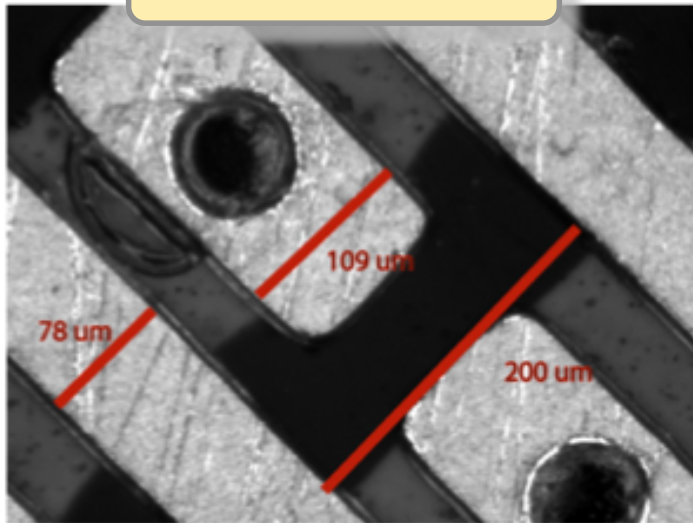
2D readout examples



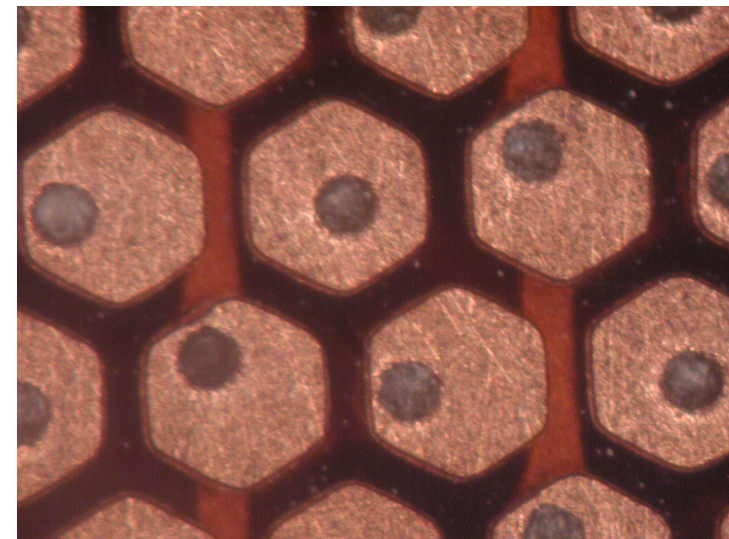
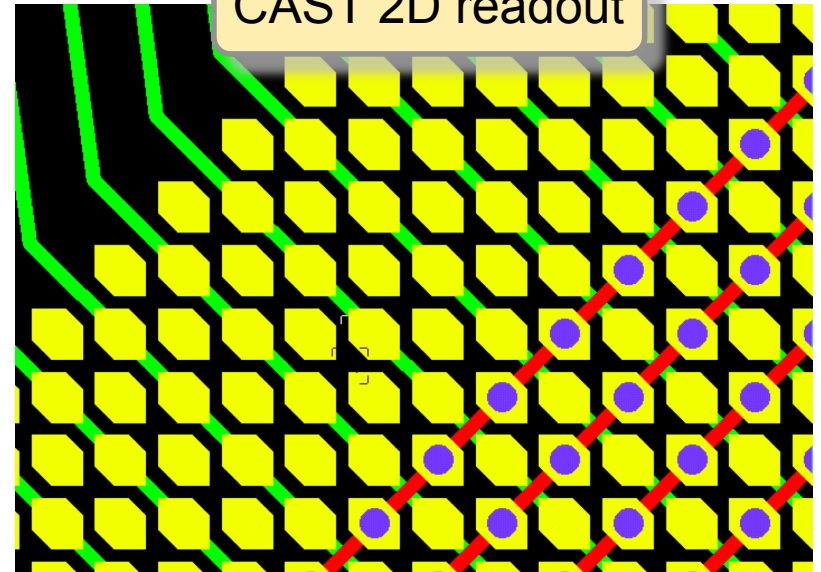
CAST 2D readout



CAST 2D readout



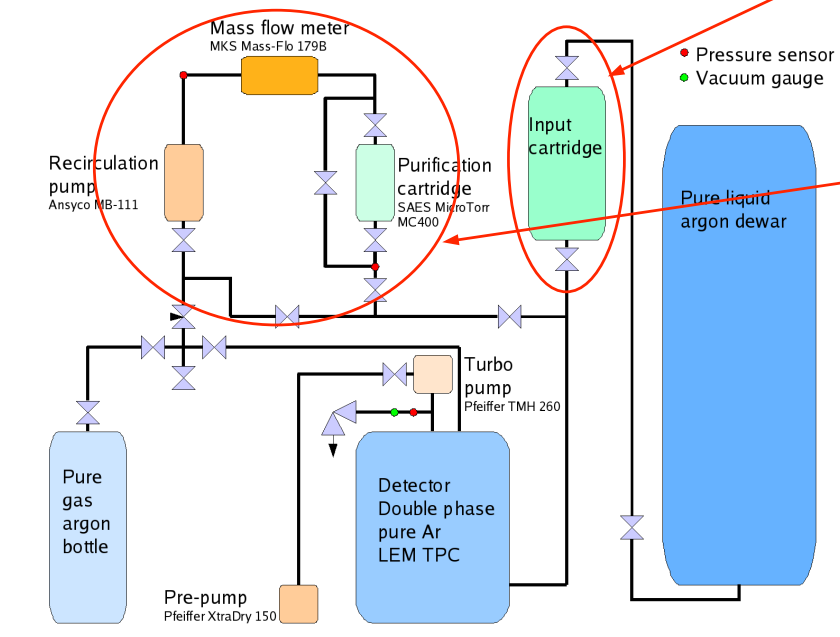
CAST 2D readout



For a 10 cm drift at 1 kV/cm, contaminations better than 10 ppb (O₂ equivalent) are needed.

To purify argon we use two purification stages:

2.10⁻⁶ mbar
pumping before
liquid filling



Input LAr purification:

- Custom made cartridge for LAr purification at detector input.

GAr purification circuit:

- Heating resistors evaporate LAr in the detector.
- A metal bellows pump pushes GAr into a flow meter and SAES getter (~48h to recirculate 1 volume).
- Purified GAr condensates into the detector volume.

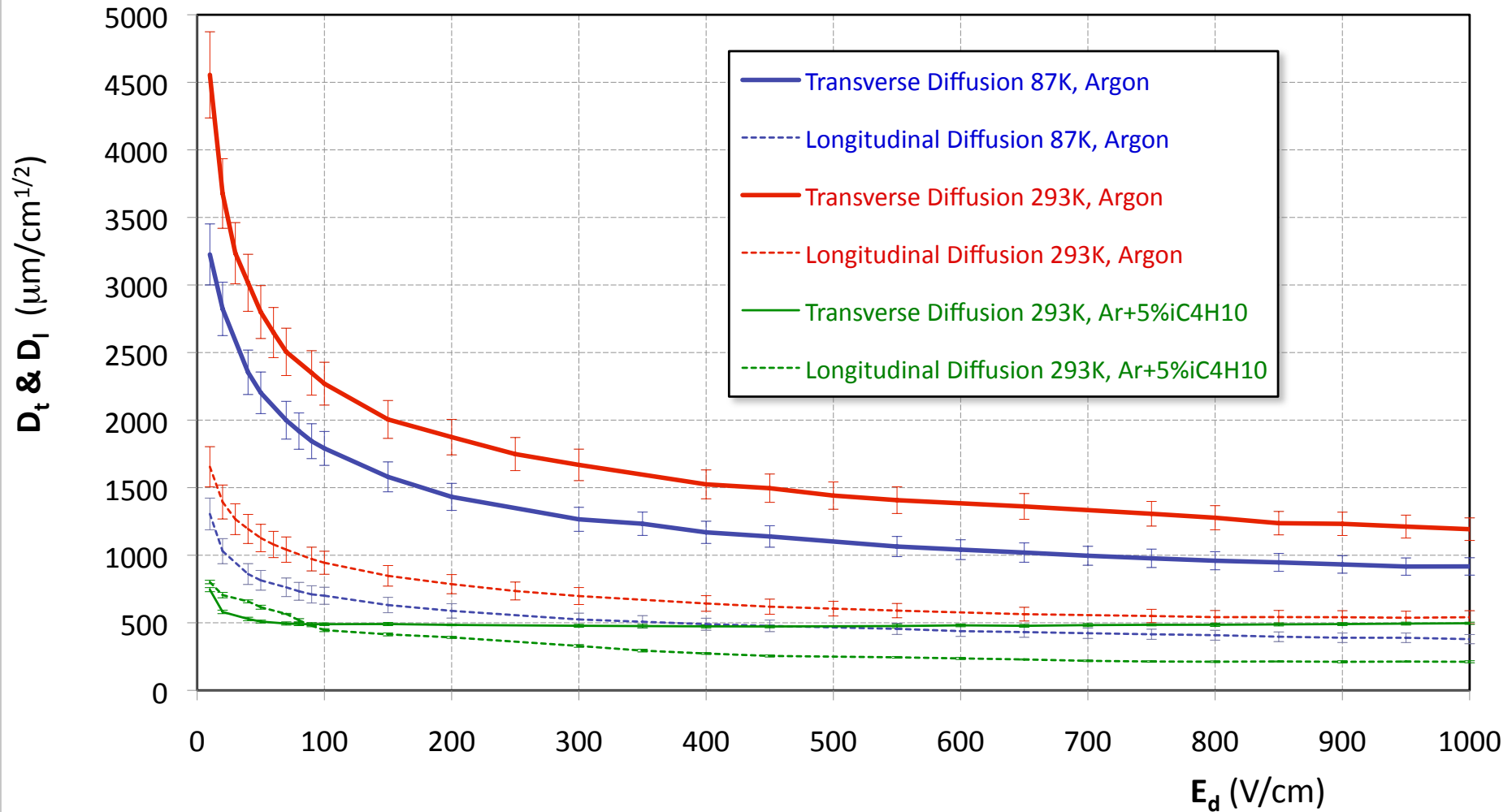


saclay



Diffusion @ 293K / 3,5 bar = Diffusion @ 87K / 1 bar

Transverse and longitudinal diffusions in Argon based mixture @ 1 atm



Diffusion @ 293K / 3,5 bar = Diffusion @ 87K / 1 bar

Transverse and longitudinal diffusions in Argon based mixtures @ 1atm

